SF101 THRU SF108

Express recovery diode Reverse Voltage50-600v Forward current-10A

Features

Glass passivated chip
High surge current capability
Ldeal for surface mounted applications
Low power loss, high efficiency
Plastic Case Material has UL Flammability

Mechanical Data

Package: DO-27

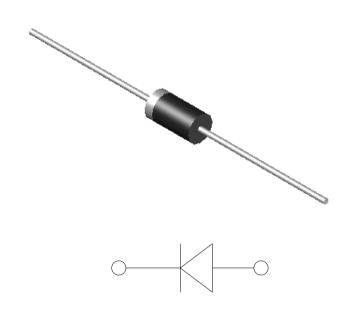
Terminals:Tin Plated leads, solderable per

Mil-STD-750 Method 2026

Polarity: As marked

Molding compound meets UL 94 V-0 flammability rating,

ROHS-compliant



Maximum Ratings (Ta=25^oC Unless otherwise specified)

Type Number	SYMBOL	SF 101	SF 102	SF 103	SF 104	SF 105	SF 106	SF 107	SF 108	Umit
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	500	600	V
Maximum RMS Voltage		35	70	105	140	210	280	350	420	V
Maximum DC Blocking Voltage		50	100	150	200	300	400	500	600	V
Maximum Average Forward Rectified Current	IO _(AV)	10.0						Α		
Peak Forward Surge Current 8.3ms Single half-sine-wave superimposed on rated load(JEDEC Method) on rated	IFSM	180.0								Α
Forward Surge Current (Non-repetitive) @1ms, square wave, 1 cycle, Tj=25°C	II OW	360.0							Α	
Current squared time @1ms≤t8.3≤ms Tj=25℃,Rating of per diode	l ² t	134.5				A^2S				
Maximum Forward Voltage at 10.0A DC	V _{FM}	0.95 1.3		.3	1.	70	V			
Maximum Reverse Current TA = 25℃	ID.	5.0								
at Rated DC Blocking Voltage TA = 125℃	- IR	100.0				uA				
Maximum reverse recovery time	Trr	35.0				ns				
Typical Thermal Resistance Between junction and	R_{QJa}	40.0			°C/W					
Operating Junction Temperature Range	T _J	—55to+150				$^{\circ}$				
Storage Temperature Range	T _{STG}	—55to+150			$^{\circ}$					

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FIG. 1MAXIMUM AVERAGE FORWARD CURRENT DERATING

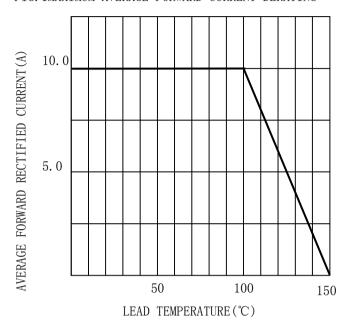


FIG. 2TYPICAL FORWARD CHARACTERISTICS

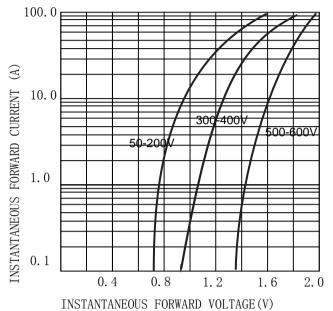


FIG. 3MAXIMUM NON-REPEITIVE SURGE CURRENT

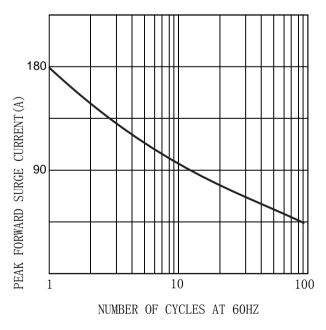
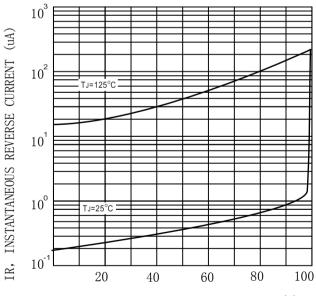


FIG. 4 TYPICAL REVERSE CHARACTERISTICS (per element)



PERCENT OF RATED PEAK REVERSE VOLTAGE (%)

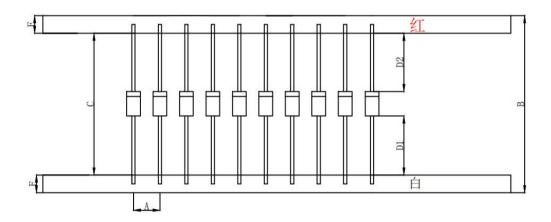


MARKING INFORMATION



Print according to customer request

PACKING REQUIRMENTS

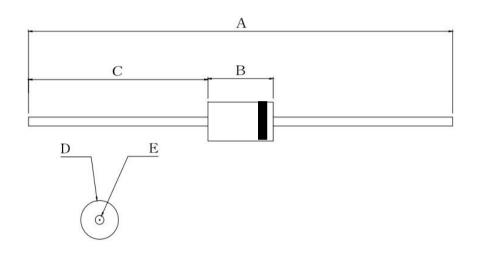


Specificati ons	Α	В	С	D1-D2	E
DO-27/MM	10± 0.5	65±2.5	52.4±0.5	1.0MAX	6.0±0.4

DEVICE	BOX/CAR	Q'TY/CAS
TYPE	TOON	E (pcs)
DO-27	1250	12500

Outline Dimensions

DO-27



D0-27						
DTM	INC	HES	MM			
DIM	MIN	MAX	MIN	MAX		
A	2. 23	2.35	56. 70	59. 70		
В	0.34	0.38	8.70	9. 70		
С	0.94	0.98	24.00	25.00		
D	0.19	0.22	4.90	5. 50		
Е	0.04	0.05	1. 10	1. 30		

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